### **UNISYS**

DATE:

July 7, 1994

PPM-94-114

TO:

S. Pszcolka/311.1 K. Sahu/300.1

FROM: SUBJECT:

Radiation Report on ISTP/SOHO/CELIAS

Part No. CD54HC4053F/3A (54HC4053)

Control No. 10468

CC:

A. Sharma/311 Library/300.1

A radiation evaluation was performed on CD54HC4053 (Analog Multiplexer/Demultiplexer) to determine the total dose tolerance of these parts. A brief summary of the test results is provided below. For detailed information, refer to Tables I through IV and Figure 1.

The total dose testing was performed using a cobalt-60 gamma ray source. During the radiation testing, two parts were irradiated under bias (see Figure 1 for bias configuration), and one part was used as a control sample. The total dose radiation levels were 2, 5, 10, 15, 20 and 50 krads\*. The dose rate was between .074 and 1.50 krads/hour, depending on the total dose level (see Table II for radiation schedule). After the 50 krad irradiation, parts were annealed at 25°C for 168 hours, after which the parts were annealed at 100°C for 168 hours. After each radiation exposure and annealing treatment, parts were electrically tested according to the test conditions and the specification limits\*\* listed in Table III. Electrical tests included six functional tests at 1.0 MHz; two at  $V_{CC} = 2.0$   $V_{cc} = 4.5$  V and two at  $V_{CC} = 6.0$  V.

All parts passed initial electrical measurements. Both irradiated parts passed all electrical and functional tests up to and including the 2 krad irradiation level. At the 5 krad irradiation level, both irradiated parts (S/N 51 and 52) exceeded the maximum specification limits of  $\pm$  2  $\mu$ A for IIZON\_2, with readings of -2.99  $\mu$ A and -3.38  $\mu$ A, respectively. After the 10 krad irradiation, both irradiated parts exceeded the maximum specification limit of  $\pm$ 1  $\mu$ A for IIZON\_1, with readings of -3.17  $\mu$ A and -3.96 $\mu$ A and continued to exceed the maximum specification limit for IIZON\_2, with readings of -8.58 and -10.16  $\mu$ A. After the 15 krad irradiation, the same failures continued, with readings of -6.57  $\mu$ A and -8.40  $\mu$ A for IIZON\_1 and -13.73  $\mu$ A and -16.66  $\mu$ A for IIZON\_2. In addition, S/N 52 exceeded the maximum specification limit of  $\pm$ 1  $\mu$ A for IIZOFF\_1, with a reading of 1.41  $\mu$ A. After the 20 krad irradiation, both irradiated parts exceededed the specification limits of  $\pm$ 1  $\mu$ A for IIZON\_1 and IIZOFF\_1, and  $\pm$ 2  $\mu$ A for IIZON\_2 and IIZOFF\_2, with maximum readings of -7.54, 3.37, -14.85 and -2.74  $\mu$ A, respectively. After the 50 krad irradiation, the same failures continued, with readings of 68.40, 68.10, -36.84 and -50.47  $\mu$ A, respectively. In addition, at the 50 krad level, both parts failed functional test # 4 (Vcc = 2.0 V).

After annealing for 168 hours at 25°C, both irradiated parts continued to fail IIZON\_1, IIZOFF\_1, IIZON\_2 and IIZOFF\_2, with maximum readings of 243µA, 233µA, 12.51µA and 15.08µA. Both irradiated parts passed all functional tests at this level. Both parts passed all other electrical tests, including the functional tests at 4.5V and 6V, throughout all irradiation and annealing steps.

After annealing for 168 hours at 100°C, no rebound effects were observed.

<sup>\*</sup>The term rads, as used in this document, means rads(silicon). All radiation levels cited are cumulative.

<sup>\*\*</sup>These are manufacturer's non-irradiation data specification limits. No post-irradiation limits were provided by the manufacturer at the time these tests were performed.

Table IV provides a summary of the functional terr results, as well as the mean and standard deviation values for each parameter after different irradiation exposures and annealing steps.

Any further details about this evaluation can be obtained upon request. If you have any questions, please call me at (301) 731-8954.

#### ADVISORY ON THE USE OF THIS DOCUMENT

The information contained in this document has been developed solely for the purpose of providing general guidance to employees of the Goddard Space Flight Center (GSFC). This document may be distributed outside GSFC only as a courtesy to other government agencies and contractors. Any distribution of this document, or application or use of the information contained herein, is expressly conditional upon, and is subject to, the following understandings and limitations:

- (a) The information was developed for general guidance only and is subject to change at any time;
- (b) The information was developed under unique GSFC laboratory conditions which may differ substantially from outside conditions;
- (c) GSFC does not warrant the accuracy of the information when applied or used under other than unique GSFC laboratory conditions;
- (d) The information should not be construed as a representation of product performance by either GSFC or the manufacturer;
- (e) Neither the United States government nor any person acting on behalf of the United States government assumes any liability resulting from the application or use of the information.

#### TABLE I. Part Information

Generic Part Number;

54HC4053

ISTP/SOHO/CELIAS

Part Number.

CD54HC4053F/3A

ISTP/SOHO/CELIAS

Control Number:

10468

Charge Number

C42954

Manufacturer:

Harris

Lot Date Code:

9332

Quantity Tested;

3

Serial Number of

Control Sample:

50

Serial Numbers of

Radiation Samples:

51, 52

Part Function:

Analog Multiplexer/Demultiplexer

Part Technology:

CMOS

Package Style:

i6-pin DIP

Test Equipment:

Sentry S-50

Test Engineer:

T. Scharer

5

#### TABLE II. Radiation Schedule for 54HC4053

EVENTS	DATE
1) INITIAL ELECTRICAL MEASUREMENTS	04/22/94
2) 2 KRAD IRRADIATION (0.10 KRADS/HOUR)	05/02/94
POST-2 KRAD ELECTRICAL MEASUREMENT	05/03/94
3) 5 KRAD IRRADIATION (0.17 KRADS/HOUR)	05/03/94
POST-5 KRAD ELECTRICAL MEASUREMENT	05/04/94
4) 10 KRAD IRRADIATION (0.25 KRADS/HOUR)	05/04/94
POST-10 KRAD ELECTRICAL MEASUREMENT	05/05/94
5) 15 KRAD IRRADIATION (0.25 KRADS/HOUR)	05/05/94
POST-15 KRAD ELECTRICAL MEASUREMENT	05/06/94
6) 20 KRAD IRRADIATION (0.074 KRADS/HOUR)	05/06/94
POST-20 KRAD ELECTRICAL MEASUREMENT	05/09/94
7) 50 KRAD IRRADIATION (1.50 KRADS/HOUR)	05/09/94
POST-50 KRAD ELECTRICAL MEASUREMENT	05/17/94
(The 50 krad irradiation was completed on 05/10/94. The parts were stored under bias at 25°C until being on 05/17/94, due to difficulties with test equipment.)	ng tested
8) 168-HOUR ANNEALING @25°C	05/17/94
POST-168 HOUR ANNEAL ELECTRICAL MEASUREMENT	06/01/94
(Parts were stored under bias at 25°C for approximately 360 hours due to test equipment problems.)	
9) 168-HOUR ANNEALING @100°C**	06/01/94
POST-168 HOUR ANNEAL ELECTRICAL MEASUREMENT	06/08/94

PARTS WERE IRRADIATED AND ANNEALED UNDER BIAS, SEE FIGURE 1.

<sup>\*</sup>High temperature annealing is performed to accelerate long term time dependent effects (TDE), namely, the "rebound" effect due to the growth of interface states after the radiation exposure. For more information on the need to perform this test, refer to MIL-STD-883D, Method 1019, Para. 3.10.1.

# TABLE IV: Summary of Electrical Measurements after Total Dose Exposures and Annealing for CD54HC4053 /1

															<del>.</del>						
						<u> </u>		Total	Dose	Expos	ure	<u>(krads)</u>							Annea		
				Initi	als	2		5		10		15		20		50		168 h	ırs	168 h	rs
		Spec.	Lim./3			1												@25°	C	@100	°C
Parameters/2		<u>min</u>	max	mean	sd	mean	sd	mean	sd	mean	sd	mean	sd	mean	sđ	mean	sd	mean	sd.	mean	sd
R_ON_1_A	Ohms	0	160	72.5	6.0	75.1	5.0		4.3	76.7	4.7	77.6	6.0	77.6	7.3	79.2	4.9	81.7	9.9	82.6	4.3
R_ON_1_B	emt()	0	160	86.3	1.1	06.5	1.3	86.0	1.6	85.6	1.4	85.4	2.4	B6.5	3.1	81.9	1.7	79.5	3.4	106	1.4
R_ON_2_A	Ohms	_ O	120	50 1	1.0	45.0	5.0	46.7	4.7	3 B . (°	3.7	49.2	4.9	47.5	6.0	48.4	3.7	45.1	5.0	46.7	4.7
R_ON_2_B	Ohms	0	120	50 1	1.8	52.6	4.4	52.5	4.3	52.5	4.3	54:2	4.9	54.2	4.9	50.1	1.8	55.1	5.0	61.7	3.7
R_PEAK_1	Ohms	0	200	118	3.5	118	5.6	120	4.5	118	4.0	118	3.9	118	2.8	115	3.3	114	12	142	17
R_PEAK_2	Ohms	0	130	74.7	4.8	75.0	7.0	37.1	5.5	77.0	4.9	77.4	5.3	78.3	3.9	77.4	5.5	76.2	1.2	85.9	2.4
IIH	υA	-1	1	0	G	' · · · · ·	0	0	0	O	0	0	0	(Cs)	0	0	C	. 0	С	0	٥
IIL	υA	-1	1	0	a	O.	0	0	0	0	0	σ	0	0	0	O	c	.8	G	0	. C i
IIZON_1_A	цĄ	-1	1	0	a	0	0	0	Ö	0.02	.02	0.47	. 51	1.17	1.3	24.2	25	1.7E4	3.7E4	0	G (
IIZON_1_B	uA	~1	1		0	C	0	+0.21	.22	-1:54	1.6	-3.23	3.3	-2.69	2.7	-3,17	4.5	-42.2	36	-0.14	.16
IIZON_2_A	UΑ	-5	2	0	0	0	0	110	0_	0.01	.01	0.16	.23	0.35	. 51	14.0	15	4.77	5.3	Ö	C
IIZON 2 B	uA	-2	2.,	0	0	-0.66	.06	-1.45	(1.5	-4.19	4.2	6.99	6.5	-6.32	5.0	-18,5	7.6	-1.78	6.4	-2.55	2.7
IIZOFF_1	uА	-1	1	0	0	0	0	OF CARE	ō~	0.03	.03	0.37	.58	17.35	1.4	22.5	24	8418	2.8E4	3	. C1
IIZOFF_1_	uА	-1	1	0	0	0	0	0	0	-0.02	-02	-0.41	.42	-0.96	. 99	715.1	16	-109	108	O	Ċ
IIZOFF_2_	uA	-2	2	0	0	0	0	C	0	0.62	.02	0.25	.26	0.56	. 57	11,3	12	4.39	4.9	C	0
IIZOFF_2_	uA	-2	2	0	0	0	0	O	0	-0.02	.02	-0.45	.46	-1.03	1.1	-16.9	18	1.72	1.9	·······································	0
TCCH_1	цĄ	0	160	g	0	0	0	1.23	.18	8,96	1.4	19.9	3.4	18.5	3.5	100	0	43.2	8.3	0.74	. 20
ICCL_1	uА	0	160	0	. 0	0	Û	3,56	.38	23.4	2.6	48.6	5.5	43.6	6 <b>.6</b>	134	34	64.1	12	11.68	-42
ICCH_2	uА	0_	320	ο	0	0.79	.07	14.6	1.3	36.8	4.2	54.3	7.5	44.7	7.1	234	34	70.5	14	9.15	2.0
ICCL_2	uА	0	320	0	0	1.61	.19	25.2	2.2	€5.5	6.7	102	11	87.5	12	202	34	110	20	25.0	5.0
TPHL_2V	nsec	Ö.	60	21.0	.77	21,3	.72	20,6	. 64	19.5	. 65	18.5	.60	17.4	.64	13.1	3.1	6.79	4.5	13.8	2.4
TPLH_2V	nsec	0	60	16.2	2.1	16.2	1.8	16.3	1.4	1.6.3	1.1	16.2	1.0	16.1	1.2	15.7	3.2	16.1	4.2	14.6	5.9
TPHL_4P5V	nsec	0	12	9.62	.47	9,66	.47	9,71	.47	9,79	، 50	9.89	. 57	9.97	.55	10.2	.73	11.0	.58	12.1	. 94
TPLH_4P5V	nsec	0	12	7.48	.65	7,53	. 64	7.59	. 64	7.61	. 62	7.65	. 62	7.70	.61	7.79	.55	0.46	.76	9,17	1.3
TPHL_6V	nsec	0	10	7.92	.53	7.98	.52	8.03	.51	8,10	.53	8,19	.59	8.25	.55	8.45	.70	9.28	.60	9: 80	.51
TPLH_6V	nsec	0	10	6.81	.24	6,86	. 27	.6.92	.25	6,95	.24	6.98	.25	7.01	.23	7.03	.19	7.44	.45	.7- 90	.84

## TABLE IV (Cont.): Summary of Electrical Measurements after Total Dose Exposures and Annealing for CD54HC4053 /1

								Total	Doge	Expos	ure l	kradel							Annea	ling	
				Initi	als	2	<del></del>	100a1	DUSE	10	ure 1	15	<del></del> "	20		50		168 h		168 h	rs -
		Spec.	Lim./3			-						-5						925°		3100	
Parameters		•			ad						د ـ						a d		- sd	mean	sd
TPH2 2V	nsec	mín O	max 210	mean 133	sd .1.5	mean 131	<u>sd</u>	mean	sd 3.765	mean 125	<u>sd</u>	mean 121	<u>sd</u> 3.2	mean	_ <u>sd</u> 6.1	mean	<u>sd</u>	mean 161	17	115	4.7
PPLZ 2V	nsec	<del></del> 0	210	71.5	.93	71.8	1.1	*** *** *** ***	1.5	73.6	2.2	74.8	2.6	7676	3.5	94.1	7.4	161	9.6	3.3E5	4 . 78:5
TPH2 495V		<del></del> 0	210	A	0.67	32.8	.70	72.5	.70	2 /			.70		.83	31.3	1.8	29.8	2.0	32.4	.73
	nsec	<u> </u>		33.0				32.7		32.5	. 68	32.3		32.1						J	
TPLZ_4P5V	nsec		42	32.0	-50	32.0	.50	32.0	.53	32.1	. 62	32.2	. 58	32.1	.72	33.5	.79	35.7	.61	31.9	2.4
TPH2_6V	nsec	0	42	24 . 5	.76	24.4	.74	24,3	.74	24.2	,76	24.1	.78	24.0	.83	23.7	.97	23.4	1.0	24.7	. 48
TPLZ_6V	nsec	0	36	23.9	- 44	23.8	. 45	23.8	.49	23.9	.48	24.0	. 52	23.9	.54	24:7	.61	26.0	.48	23,5	1.8
TP2H_2V	nsec	0	36	73,9	1.3	73.9	1.5	74.0	1.7	74.6	2.5	76.7	3.3	80.7	4.3	123	18	272	54	169	21
TPZL_2V	nsec	0	220	в3,0	1.4	82.5	1.5	82.0	1.7	82.2	2.4	<b>8J.</b> 5	3.2	87.1	4.2	1.7E5	3.7£5	263	38	3.3E5	4.7E5
TPZH_4P5V	nsec	٥	220	19,5	.37	19.5	.36	19.5	.35	19.€	.40	19.7	.42	20,0	.48	21.5	1.4	26.0	3.¢	25.0	1.3
TPZL_4P5V	nsec	O	44	20.2	. 37	20.3	. 32	20.3	.33	20.4	.31	20.4	. 33	20.6	. 34	20.9	.65	20.5	. 22	26.8	
TP2H_6V	nsec	Э	44	15,7	. 34	15.7	. 33	15.8	. 34	15.8	.34	15,9	.33	15.1	. 37	47.0	.82	19.1	1.6	18.8	.32
TPZL_6V	nsec	0	37	15.6	.29	15.6	.28	15.6	. 27	15.đ	.27	_5.6	.23	15.7	.23	15.4	.16	14.9	.17	19	.94
FUNC1, 2.0V,	1 MHz	-	-	⊋ASS		PASS		PASS		PASS		PASS		PASS		PASS	_	PASS		PASS	
FUNC2, 4.5V,	1 MHz	<b>-</b>	_	PASS		PASS		PASS		PASS		PASS		PASS		PASS		PASS		FASS	
FUNC3, 6.0V,	1 MHz	_		FASS		PASA		PASS		PASS	·	PASS		PASE		PASS		PASS		PASS.	
FUNC4, 2.0V,	1 MHz		-	PASS		PASS.		PASS		PASS		PASS		PASS		FAIL		PASS		PASS	
FUNC5, 4.5V,	1 MHz	-	-	PASS		PASS		PASS		PASS		PASS		PASS	-	PASS		PASS		PASS	
FUNCE, 6.0V,	1 MHz	<u>-</u> .	- 1	PASS		PASS		PASS		Pass		PASS		PASS		FASS		PASS		PASS	

<sup>1/</sup> The mean and standard deviation values were calculated over the three parts irradiated in this testing.

The control sample remained constant throughout the testing and is not included in this table.

<sup>2/</sup> In the functional tests, "PASS" means that all samples passed this functional test at this radiation or annealing level, "FAIL" means that all samples failed this test at this radiation or annealing level, and "nP/mF" means that n samples passed at this level and m samples failed at this level.

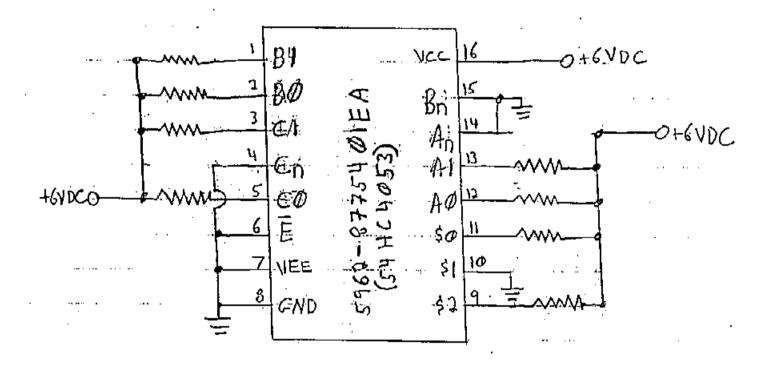
<sup>3/</sup> These are manufacturer's non-irradiated data sheet specification limits. No post-irradiation limits were provided by the manufacturer at the time the tests were performed.

Table III. Electrical Characteristics of 54HC4053

	<b></b>		
( 		FUNCTIONAL TESTS PERF	CRMED
무료무료 글로 글로 글	CC VIL VI		_ 7
A0,A1,80,B1,c FUNCT 1 2 FUNCT 2 4 FUNCT 3 6	0,01 ARE DRI'	VEN AS INPUTS; AN,EN,E 5V FREG=1.000MHZ ALL 15V FREG=1.000MHZ ALL	
FUNCT 5 4	DRIVEN AS INI .0V 0.3V 1. .5V 0.9V 3. .0V 1.2V 4.	IDV KKERFT.DUUMHI ALL	1 ARE COMPARED AS OUTPUTS
	D:	C PARAMETRIC TESTS PER	REGRMED
PARAMETER VCC	YEE YIL	ROUTIONO HIV	PINS +25C
R_ON_1_A 4.5		3.15V VIS=4.5V IO=1MA	OUTS >+0.00KMS, <+1600HMS
R_ON_1_8 4.5		3.15V VIS=0.0V IO=1MA	OUTS >+0.00HMS, <+1600HMS
•	V -4.5V 0.9V	. 3.15v vis#4.5v io=1MA	OUTS >+0.00HMS, <+1200HMS
R_ON_2_8 4.5	V -4.5V 0.9V	3.15V VIS=-4.0V IO=1MA	OUT\$ >+0.00HMS, <+1200HMS
PARAMETER VCC	VEE VIL	VIH CONDITIONS	PINS -55C/+125C
R_ON_1_A 4.5		3.15V VIS=4.5V 	OUTS >+0.00HMS, <+24COHMS
R_ON_1_8 4.5		3.15V VÍS≜ÖÜÖV IO=1MA	OUTS >+0.00HMS, <+2400HMS
	V -4.5V 0.9V	3.15v VIS=4.5v IO=1MA	OUTS >+0.00HMS, <+1800HMS
R_ON_2_8 4.5	/ -4.5V 0.9V	3-15V VIS=-4.0V IQ=1MA	OUTS >+0.00HMS, <+1800HMS
PARAMETER VCC	VEE VIL	VIH CONDITIONS	PINS +25c
R_PEAK_1 4.5	/ OV 0.9V	3.15V 10=1MA VIS=0V TO 4.5V IN	OUTS >+0.00HMS, <+2000HMS
R_PEAK_2 4.5\	/ -4.5 0.9V	3.15V TO = 1MA VIS = -4.0V TO 4.5V	O.5V INCREMENTS OUTS >+0.00HMs, <+1300HMS IN 0.5V INCREMENTS
PARAMETER VCC	VEE VIL	NOITIONS HIV	_PINS550 < TC < +1250
R_PEAK_1 4.5v		3.15V TO=1MA	0175 340 0004c 22700004c
R_PEAK_2 4.5V	-4.5 0.90	VIS=0V TO 4.5V IN 3.15V IO=1MA	O.5V INCREMENTS OUTS >+0.00HMs, <+1950HMS

VIS=-4.0V TO 4.5V IN 0.5V INCREMENTS    PARAMETER
IIH
PARAMETER VCC VEE VIL VIH CONDITIONS PINS -55C < TC < +125  ENABLE IS LOGIC ZERO  111ZON-1-A 6.0V 0.0V 1.2V 4.2V VIS=0.0V,NO LOAD INS >-1UA / <+1UA /
PARAMETER
PARAMETER   VCC   VEE   VIL   VIH   CONDITIONS   PINS   -55C   TC   +125     ENABLE IS LOGIC ONE   1.2V   4.2V   VIS=6.0V   VOS=0.0V   INS   >-1UA   <+1UA     IIZON 1
PARAMETER
PARAMETER
100L-1
PARAMETER VCC VEE VIL VIH CONDITIONS PINS +25c
\ TPHL 2V
PARAMETER VCC VEE VIL VIH CONDITIONS PINS +250
\TPHI_2V 2.0V 0.0V 2.0V LCAD=1MA EN TO OUT >+0.0NS / <+210NS \TPLI_2V 2.0V 0.0V 2.0V LOAD=1MA EN TO OUT >+0.0NS / <+210NS \TPLI_4P5 4.5V 0.0V 0.0V 4.5V LOAD=4.5MA EN TO OUT >+0.0NS / <+42NS \TPLI_4P5 4.5V 0.0V 0.0V 4.5V LOAD=4.5MA EN TO OUT >+0.0NS / <+42NS \TPHI_2-4V 6.0V 0.0V 0.0V 4.5V LOAD=6MA EN TO OUT >+0.0NS / <+36NS \TPLI_6V 6.0V 0.0V 0.0V 6.0V LOAD=6MA EN TO OUT >+0.0NS / <+36NS
PARAMETER VCC VEE VIL VIH CONDITIONS PINS +25c
\ TPZH_2V

Figure 1. Radiation Bias Circuit for 54HC4053



- 1)  $V^{CC} = +6.0 \text{ VDC} \pm 600 \text{ mV}$
- 2) All R = 6.2 k\_  $\pm$  10 %, 1/4 W (minimum).